

### **5 A Schottky Barrier Rectifier**

### **DESCRIPTION**

In Microsemi's new Powermite® SMT package, these high efficiency Schottky rectifiers offer the power handing capabilities previously found only in much larger packages. They are ideal for SMD applications that operate at high frequencies.

In addition to its size advantages, Powermite® package features include a full metallic bottom that eliminates the possibility of solder flux entrapment during assembly, and a unique locking tab acts as an integral heat sink. Its innovative design makes this device ideal for use with automatic insertion equipment.

**IMPORTANT:** For the most current data, consult *MICROSEMI*'s website: http://www.microsemi.com

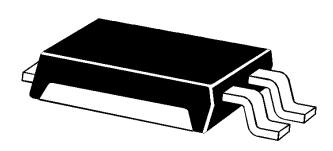
#### ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED) Rating **Symbol** Value Unit $V_{RRM}$ Peak Repetitive Reverse Voltage Working Peak Reverse Voltage 60 V $V_{RWM}$ DC Blocking Voltage $V_R$ RMS Reverse Voltage 42 V VR (RMS) Average Rectified Output Current 5 Α lo Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine wave Superimposed 100 Α IFSM on Rated Load@ Tc =90 °C Storage Temperature -55 to +150 °C T<sub>STG</sub>

THERMAL CHARACTERISTICS (UNLESS OTHERWISE SPECIFIED)							
Thermal Resistance							
Junction-to Tab	$R_{ heta JTAB}$	7.5	°C/Watt				
Junction-to Bottom	$R_{ heta JC}$	2.5	°C/Watt				

ТJ

-55 to +125

°C



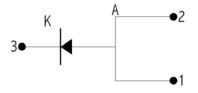
Junction Temperature

#### **KEY FEATURES**

- High power surface mount package
- Guard Ring die construction for transient protection
- Internal heat sink locking tabs
- Low forward voltage
- Full metallic bottom eliminates flux entrapment
- Compatible with automatic insertion equipment
- Low profile-maximum height of 1mm supplied in 16 mm tape reel- 5000 units/ 13" reel.

#### APPLICATIONS/BENEFITS

- Switching and Regulating Power Supplies
- Silicon Schottky (hot carrier) rectifier for minimal reverse voltage recovery
- Elimination of reverse-recovery oscillations to reduce need for EMI filtering
- Charge Pump Circuits
- Reduces reverse recovery loss due to low I<sub>RM</sub>
- Small foot print
   190 X 270 mils (1:1 Actual size)
   See mounting pad details on pg 4





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Parameter	Symbol	Conditions	Min	Тур.	Max	Units
Forward Voltage (Note 1) V <sub>Fm</sub>	I <sub>F</sub> = 5 A , T <sub>j</sub> = 25 °C		0.65	0.69		
		I <sub>F</sub> = 5 A , T <sub>i</sub> = 125 °C		0.56	0.60	V
	V <sub>Fm</sub>	$I_F = 5 \text{ A}, T_j = 125 \text{ °C}$ $I_F = 8 \text{ A}, T_j = 25 \text{ °C}$		0.74	0.78	
		I <sub>F</sub> = 8 A , T <sub>i</sub> = 125 °C		0.64	0.68	
Reverse Break Down Voltage						
(Note 1)	$V_{BR}$	I <sub>R</sub> = 0.2 mA	60			V
,						
Reverse Current (Note1)		V <sub>R</sub> = 60 V, T <sub>i</sub> = 25°C		2	200	μА
,	I <sub>m</sub>	V <sub>R</sub> = 60 V, T <sub>i</sub> =125 °C		0.6	20	mΑ
Capacitance	Ст	V <sub>R</sub> = 4 V: F = 1 MH <sub>2</sub>		150		pF

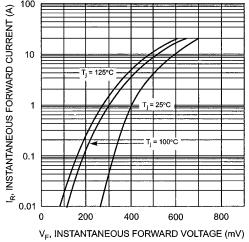
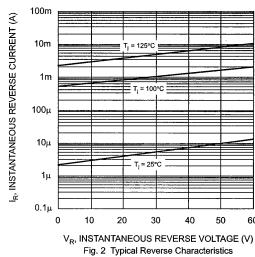


Fig. 1 Typical Forward Characteristics



Note: 1 Short duration test pulse used to minimize self – heating effect.

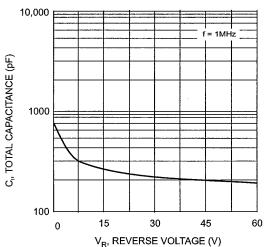
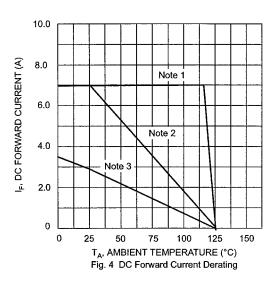
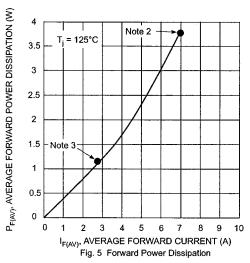


Fig. 3 Typical Capacitance vs. Reverse Voltage



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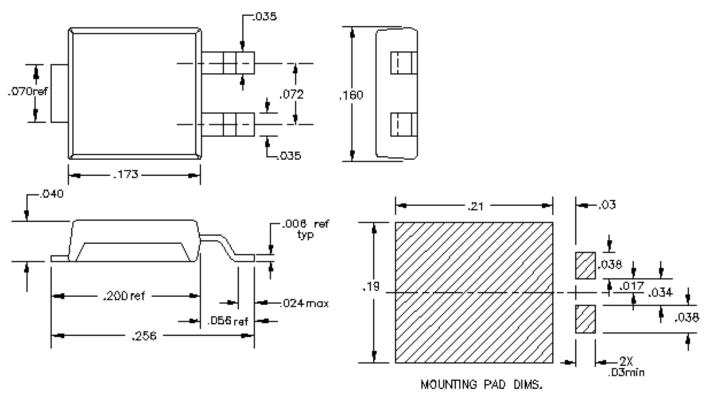


- NOTE 1:  $T_A$  =  $T_C$  at case bottom where  $R_{\theta JC}$  =2.5° C/W and  $R_{\theta CA}$  = 0° C/W (infinite heat sink).
- NOTE 2: Device mounted on GETEK substrate, 2" x 2", 2 oz. copper , double-sided , cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0".  $R_{\theta JA}$  in range of 20-35° C/W.
- NOTE 3: Device mounted on FRA-4 substrate, 2" x 2", 2 oz. copper, single-sided, pad layout R<sub>0JA</sub> in range of 75 100° C/W.

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NOTE: LEAD FRAMES ARE Sn/Pb PLATED.



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NOTES: